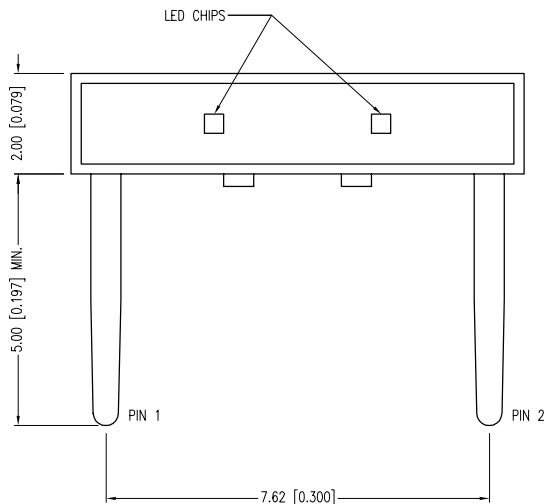
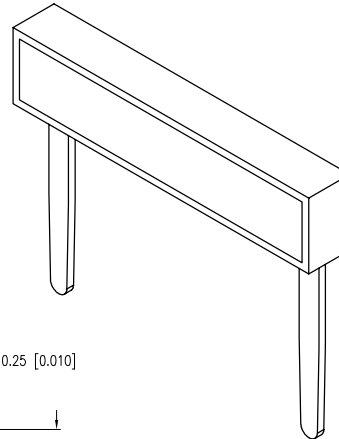
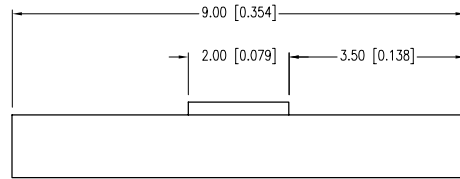
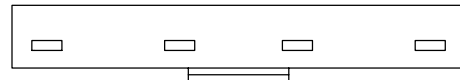
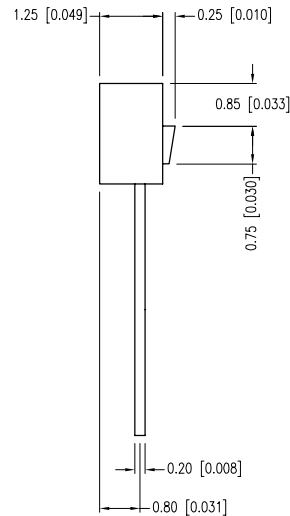


PART NUMBER	SSB-LX02GC-AU	REV.	C
DATE	E.C.N. NUMBER AND REVISION COMMENTS		REV.
02.18.93	REDRAWN, NEW MOLD.		A
07.18.95	UPDATED SPEC. WHERE NOTED.		B
3.30.11	E.C.N. #10BRDR. & REDRAWN.		C



1 2

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		4.4	5.2	V_f	
REVERSE VOLTAGE	10			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY		10		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		160		2x theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	GREEN TRANSPARENT				

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/ $^\circ\text{C}$
OPERATING TEMP.	-20 TO +85	$^\circ\text{C}$
STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+240	$^\circ\text{C}$
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

NOTES:

1. GOLD WIRE BONDING ONLY.

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X= ± 1 (± 0.039), X.X= ± 0.5 (± 0.020), X.XX= ± 0.25 (± 0.010), X.XXX= ± 0.127 (± 0.005). LEAD SIZE= ± 0.05 (± 0.002), LEAD LENGTH= ± 0.75 (± 0.030). MIN.= $^{+0.00}_{-0.00}$ DECIMAL PRECISION MAX.= $^{+0.00}_{-0.00}$ DECIMAL PRECISION